

iW765

Zero Standby Power AC/DC Secondary-Side Regulation Controller with Integrated Synchronous Rectification for USB PD 3.1 w/PPS

The iW765 is an AC/DC secondary-side controller for USB Power Delivery (PD) 3.1 with Programmable Power Supply (PPS) support which integrates a secondary-side regulation controller, interface protocol controller, USB V_{BUS} driver and synchronous rectifier controller into a single IC. The iW765 is designed for higher output power applications up to 100W+.

The iW765 allows rapid charge of USB PD PPS enabled mobile devices (MDs). It resides on the secondary side of an AC/DC travel adapter (TA) and allows the TA to be configured for multi-level output voltage and current.

The device also provides a peak power capability to allow for higher output current prior to entering constant-current mode.

The iW765 measures the output voltage and load current and sends the results to a digital compensator for closed-loop control of flyback converter. The digital control signal generated by the compensator is converted to an analog signal and transferred to primary controller via an optocoupler.

The iW765 controller is a hard-wired state machine, so no MCU coding is required. This eliminates potential malicious or inadvertent access to chargers or power supplies designed with the iW765 and prevents them from sourcing volt- ages via the USB cable higher than a smartphone, tablet, laptop or other product can handle, which may damage the product.

The iW765 is also an advanced synchronous rectifier (SR) controller with an integrated MOSFET driver. The device works with an external power MOSFET to replace the main rectifying diode on the secondary of a flyback converter. The SR control block with proprietary technologies optimizes the SR on/off timing and driving voltage to achieve best efficiency.

The iW765 should be paired with Renesas' high power-density Flyback primary-side controllers such as the iW9860 or iW9870 to achieve high efficiency, accurate voltage/current control and fast dynamic load response. Furthermore, iW9860/iW9870 and iW765 can enter an extremely low consumption state when MD is unplugged so that TA standby power is < 5mW (Zero standby power¹).

Features

- Zero standby power consumption with lowest system cost (< 5mW at 230V_{AC} when output USB cable is detached in a typical 45W USB PD travel adapter)¹
- Supports USB PD3.1 with PPS for output voltage from 3.3V to 21V in 20mV steps and output current in 50mA steps
- Proprietary peak power mode operation support
- High resolution accuracy multi-level output voltage and current control
- Built-in digital loop compensation to minimize the external component count
- Built-in synchronous rectification controller with integrated driver
- Optimized V_{DS}-based SR timing and driving control with wide output range
- Supports D- Impedance detection
- NFET driver for V_{BUS} switch
- Active fast discharge from a high voltage to 5V at MD unplug or from a high voltage level to a lower level upon request
- Hard-wired state machine
 - No MCU and firmware required
 - Prevents chargers and power supplies from being hacked and damaged
- Supports DCM and CCM operation
- 14-Lead TDFN package

Applications

 AC/DC adapters for USB PD enabled smart phones, tablets and other mobile devices

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1. Overview

1.1 Typical Application

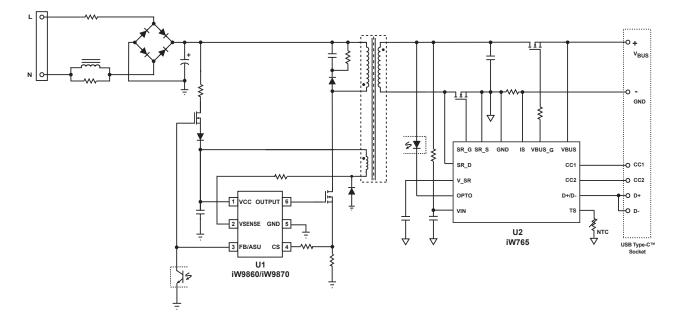


Figure 1. iW765 Typical Application Circuit for Multi-Level Voltage and Current (Using iW9860 as Primary-Side Controller, Achieving < 5mW No-Load Power Consumption).

2. Pin Information

2.1 Pin Assignments

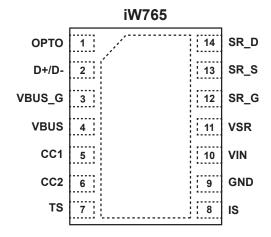


Figure 2. Top View

2.2 Pin Description

| Pin Number | Pin Name | Туре | Description |
|------------|----------|-----------------------|--------------------------------------------------------------------------------------------------------|
| 1 | ОРТО | Analog Output | Optocoupler driver to transfer the output regulation control signal to primary side. |
| 2 | D+/D- | Analog Input/Output | USB D+/D- signal, tied together. |
| 3 | VBUS_G | Analog Input/Output | Gate drive for external N-FET switch. |
| 4 | VBUS | Analog Input/Output | Connect to V _{BUS} after N-FET switch. |
| 5 | CC1 | Analog Input/Output | Communication channel 1. |
| 6 | CC2 | Analog Input/Output | Communication channel 2. |
| 7 | TS | Analog Input/Output | Temperature sensing pin. Connect to an external NTC resistor to measure the power adapter temperature. |
| 8 | IS | Analog Input | Output current sensing, connect to current sensing resistor "+" terminal. |
| 9 | GND | Ground | Ground, connect to current resistor "-" terminal. |
| 10 | VIN | Power Analog Input | Input of the internal LDO and output voltage sensing circuit. |
| 11 | V_SR | Power | Voltage supply for SR drive. Connect this pin to a capacitor. |
| 12 | SR_G | Analog Output | Synchronous rectifier MOSFET driver. |
| 13 | SR_S | Analog Input | Synchronous rectifier MOSFET source input. |
| 14 | SR_D | Analog Input | Synchronous rectifier MOSFET drain voltage sensing and the Pulse Linear Regulator (PLR) input. |

3. Specifications

[The spec data in the following tables is for example purposes only and will vary per device or technology.]

3.1 Absolute Maximum Ratings

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions can adversely impact product reliability and result in failures not covered by warranty.

| Parameter | Symbol | Minimum | Maximum | Unit |
|------------------------------------------------------------------|--------------------|---------|---------|------|
| V_{VIN} DC supply voltage range (I _{VIN} = 12mA max) | V _{VIN} | -0.3 | 25 | V |
| Continuous DC supply current at VIN pin (V _{VIN} = 12V) | I _{VO} | | 12 | mA |
| SR_G peak output current | I _{SR_G} | | ±2 | A |
| SR_G voltage | V _{SR_G} | -0.6 | 6 | V |
| SR_D voltage (Note 1) | V _{SR_D} | -1.5 | 100 | V |
| SR_D peak current | I _{DRAIN} | -40 | 300 | mA |
| SR_S voltage | V _{SR_S} | -0.5 | 6 | V |
| V_SR voltage | V_{V_SR} | | 6 | V |
| OPTO voltage | V _{OPTO} | -0.6 | 25 | V |
| D+/D- voltage | V _{D+/D-} | -0.3 | 25 | V |
| CC1 voltage | V _{CC1} | -0.3 | 25 | V |
| CC2 voltage | V _{CC2} | -0.3 | 25 | V |
| IS voltage | V _{IS+} | -0.3 | 7 | V |
| TS voltage | V _{SD} | -0.3 | 7 | V |
| VBUS voltage (IBUS < 10mA) | V _{VBUS} | -0.7 | 25 | V |
| VBUS_G voltage | V_{VBUS_G} | -0.7 | 30 | V |
| Maximum Junction Temperature | T _{JMAX} | -40 | 150 | °C |
| Maximum Storage Temperature Range | T _{STG} | -65 | 150 | °C |
| ESD Rating | Value | | Unit | |
| Human Body Model (Tested per JS-001-2017) (CC1/CC2 | ±8,000 | | V | |
| Human Body Model (Tested per JS-001-2017) (all other p | ±2,000 | | V | |
| Latch-Up (Tested per JESD78E; Class 2, Level A) | ±100 | | mA | |

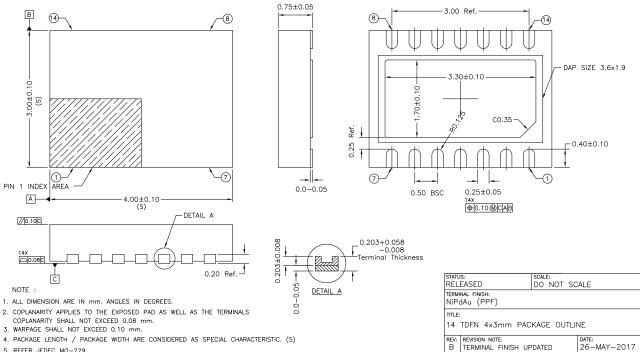
1. The DRAIN pin voltage should not be below -0.6V for more than 500ns.

3.2 Thermal Specifications

| Thermal Resistance (Typical) | θ _{JA} (°C/W) [1] | | |
|------------------------------|----------------------------|--|--|
| 14-Led SOIC Package | TBD | | |

Package Outline Drawings 4.

The package outline drawings are located at the end of this document and are accessible from the Renesas website. The package information is the most current data available and is subject to change without revision of this document.



5. REFER JEDEC MO-229.

Figure 3. 14-Lead TDFN Package

Ordering Information 5.

| | Options | | | | | |
|---------------|------------------------------------------------|-----------------|--------------------------|----------------------------|-----------------|--------------------------|
| Part no. | Protocol and V/I Profile | Output Power | Peak Power Support | Primary-Side Controller | Package | Description |
| iW765-XX-YYYY | USB PD 3.1 PDO & APDO: support up to TBD | TBD | TBD | iW9860 iW9870 | 14-Lead TDFN | Tape & Reel ¹ |

Tape & Reel packing quantity is 3,000/reel. Minimum packing quantity is 3,000. 1.

Part Number Code Description 6.

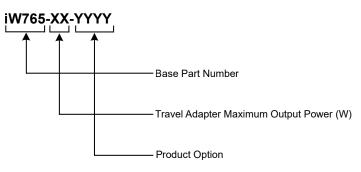


Figure 4. iW765 Part Number Decoder

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Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Contact Information

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